



About

Input Box

TERMS OF USE

Step 1: Operating Specifications

Input Voltage – Min, $V_{IN(min)}$	30 V
Input Voltage – Nom, $V_{IN(nom)}$	48 V
Input Voltage – Max, $V_{IN(max)}$	60 V
Output Voltage, V_{OUT}	15 V
Maximum Output Current, I_{OUT}	15 A
Free-running Switching Frequency, F_{SW}	215 kHz
SYNC Frequency (if used), $F_{SW-SYNC}$	kHz
Frequency Set Resistor, R_{RT}	46.4 k Ω

Step 2: Filter Inductor

Recommended Filter Inductance	9.6 μ H
Inductance, L_F	10 μ H
Inductor DCR	2.86 m Ω
Pk-to-Pk Ripple Current at $V_{IN(nom)}$, ΔI_L	4.8 A _{pk-pk}
Inductor Ripple Current as a % of Max I_{OUT}	32 %

Step 3: $R_{DS(on)}$ or Shunt-Based Current Limit

Required Current Limit Setpoint	15 A
Current Limit Set Resistor, R_{LIM}	402 Ω
Min Inductor Sat Current, $I_{L(SAT)}$	20.4 A

Step 4: Output Capacitance

Output Voltage Ripple Specification	10 mV _{pk-pk}
Minimum Ideal Output Capacitance	281 μ F
Total Output Capacitance (Derated), C_{OUT}	330 μ F
Maximum Permitted ESR	1 m Ω
Output Capacitor ESR	20 m Ω
Resulting Output Voltage Ripple	97 mV _{pk-pk}
Output Capacitor Ripple Current	1.4 A (rms)

Step 5: Input Capacitance

Input Voltage Ripple Specification	500 mV _{pk-pk}
Minimum Ideal Input Capacitance	30 μ F
Total Input Capacitance (Derated), C_{IN}	47 μ F
Maximum Permitted ESR	10 m Ω
Input Capacitor ESR	100 m Ω
Resulting Input Voltage Ripple	2063 mV _{pk-pk}
Input Capacitor Ripple Current	7.0 A (rms)

Step 6: Soft-start, UVLO

Soft-Start Time, t_{SS}	4 ms
Soft-Start Capacitance, C_{SS}	47 nF
Input Voltage UVLO Turn-On	14 V
Input Voltage UVLO Turn-Off	13 V
UVLO Upper Resistor, R_{UV1}	100 k Ω
UVLO Lower Resistor, R_{UV2}	9.31 k Ω

If the SYNC feature is not required, connect SYNCIN to GND or VCC for DCM or CCM operation, respectively

Step 7: Compensation Design

LC Complex Pole Frequency	2.7 kHz
ESR Zero Frequency	24 kHz
Desired Crossover Frequency	50 kHz
Appropriate Midband Gain	1.21 V/V
Upper Feedback Resistor, R_{FB1}	18 k Ω
Lower Feedback Resistor, R_{FB2}	1.02 k Ω
Actual Output Voltage, V_{OUT}	14.918 V

Pole & Zero Placement	F_{Z1}	1.9 kHz
Baseline P/Z Frequencies:	F_{Z2}	2.5 kHz
	F_{P1}	24 kHz
	F_{P2}	108 kHz

Compensation Components

Calculated / Std Values	Selected	Actual P/Z Frequencies
R_{C1} 21.8	22.1	22 k Ω
C_{C1} 3789	3900	3900 pF
C_{C2} 69	68	47 pF
R_{C2} 2056	2050	2020 Ω
C_{C3} 3210	3300	3300 pF

** Specify Inductor Core Loss ** 0.4 W

Efficiency / Power Loss Analyzer

Step 8: Efficiency

High-Side MOSFET (Q_1) Specifications		NVMFS6B25NL
On-State Resistance, $R_{DS(on)}$	6.5 m Ω	
Total Gate Charge, Q_G	37 nC	
Gate-Drain Charge, Q_{GD}	6.7 nC	
Gate-Source Charge, Q_{GS}	10.5 nC	
Output Capacitance, C_{OSS}	738 pF	
Gate Resistance, R_G	2 Ω	
Transconductance, g_{FS}	82 S	
Gate-Source Threshold Voltage, $V_{GS(TH)}$	2.7 V	
Body Diode Forward Voltage, V_{SD1}	0.8 V	
Thermal Resistance, θ_{JA}	50 $^{\circ}$ C/W	

Low-Side MOSFET (Q_2) Specifications		NVMFS6B14NL
On-State Resistance, $R_{DS(on)}$	6.4 m Ω	
Total Gate Charge, Q_G	31 nC	
Output Charge, Q_{OSS}	43 nC	
Output Capacitance, C_{OSS}	1350 pF	
Body Diode Forward Voltage, V_{SD2}	1.2 V	
Body Diode Recovery Charge, Q_{RR}	84 nC	
Thermal Resistance, θ_{JA}	50 $^{\circ}$ C/W	

Antiparallel Schottky Diode (if applicable)

Schottky Diode Forward Voltage, V_{SD}	0 V
Schottky Diode Recovery Charge, Q_{RR2}	0 nC

